

Title (en)

MODULAR HEAT EXCHANGE SYSTEM FOR USE IN CENTRAL HEAT EXCHANGE INSTALLATIONS IN BUILDINGS

Title (de)

MODULARES WÄRMEAUSTAUSCHSYSTEM ZUR VERWENDUNG IN ZENTRALEN WÄRMEAUSTAUSCHANLAGEN IN GEBÄUDEN

Title (fr)

SYSTÈME D'ÉCHANGE DE CHALEUR MODULAIRE POUR UNE UTILISATION DANS DES INSTALLATIONS D'ÉCHANGE DE CHALEUR CENTRALES DANS DES IMMEUBLES

Publication

EP 2229569 A2 20100922 (EN)

Application

EP 08760875 A 20080611

Priority

- EP 2008057327 W 20080611
- US 93488507 A 20071105

Abstract (en)

[origin: US2009114381A1] A modular heat exchange system for use in a central heat exchange installation in buildings, including at least one heat exchange element equipped for exchanging heat between environmental air and a fluid which is conducted through the heat exchange element. The heat exchange element has a predetermined first shape with opposite lateral sides. At least one non-heat-exchange add-on element, equipped for adding a given additional functionality to the system, has a predetermined second shape with a complementary lateral side to one of the opposite lateral sides of the heat exchange element.

IPC 8 full level

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CPC (source: EP US)

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Citation (search report)

See references of WO 2009059811A2

Designated contracting state (EPC)

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Designated extension state (EPC)

AL BA MK RS

DOCDB simple family (publication)

US 2009114381 A1 20090507; **US 8347950 B2 20130108**; CN 102016477 A 20110413; CN 102016477 B 20130206; EP 2229569 A2 20100922; EP 2236968 A2 20101006; EP 2236968 A3 20160120; EP 2236968 B1 20180808; ES 2694504 T3 20181221; HK 1155801 A1 20120525; JP 2011503501 A 20110127; JP 5334065 B2 20131106; PL 2236968 T3 20190731; TR 201816629 T4 20181121; WO 2009059811 A2 20090514; WO 2009059811 A3 20100819

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US 93488507 A 20071105; CN 200880123824 A 20080611; EP 08760875 A 20080611; EP 10165558 A 20080611; EP 2008057327 W 20080611; ES 10165558 T 20080611; HK 11110144 A 20110926; JP 2010532516 A 20080611; PL 10165558 T 20080611; TR 201816629 T 20080611